

# HSF RoHS

## SPECIFICATIONS

Rated Current:2.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:500V AC/DC

Insulation Resistance:500MΩ Min

Operation Temperature:-40°C to +105°C

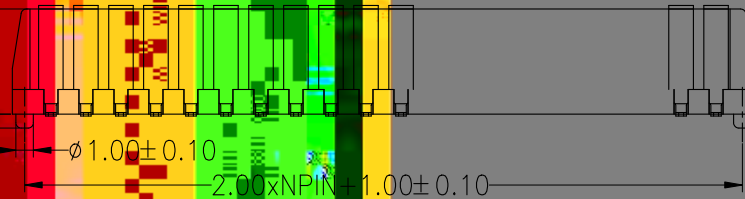
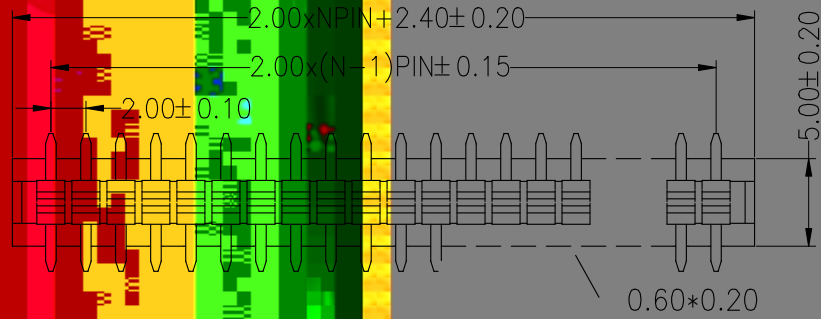
Contact Material:Copper Alloy

Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Resistance To Soldering Heat:

260°C±5°C, 10s(PA9T insulator)



## Ordering Information

4400- 2 XX M XX M E B W 0 X

No.of Pins

2x13P  
2x15P  
2x20P  
2x23P  
2x25P  
2x27P

Contact Plating

G0:Gold Flash  
G1:1U" Gold  
G2:2U" Gold  
G3:3U" Gold  
G4:5U" Gold  
G5:10U" Gold

Recommended P.C.B Layout(Top Side)

OPERATION

X.X ±0.30

X.XX ±0.20

X.XXX ±0.10

Angle ±3°

DIM TO

DRAW

OuYanghui

18.05.16

CHECK

APPROVE

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

⊕

PART NO.

4400-2XXMXXMEBW0X

TITLE:

2.0金手指连接器 2xNP 公座 H6.0 SMT

A0 2018.05.16 NEW DRAWING

REV DATE MODIFICATION DESCRIPTION

CHANGE

1

2

3

4

5

6

7

8

9